Electronic Patent Application Fee Transmittal							
Application Number:	10534962						
Filing Date:	16-May-2005						
Title of Invention:	Circuit board, multi-layer wiring boards, method of producing circuit boards and method of producing multilayer wiring boards						
First Named Inventor/Applicant Name:	Masayoshi Kondo						
Filer:	Robert G. Weilacher/Susan Revell						
Attorney Docket Number:	033036.088						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Fil	ing	Fees					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:					1		
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 2 months with \$0 paid		1252	1	460	460		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			460